



Asetek Continues Market Moment with Latest Order for RackCDU

June 22, 2016 – Asetek® announced today that it has received an order from one of its existing OEM partners. The order for RackCDU D2C™ (Direct-to-Chip) is to satisfy an undisclosed HPC customer installation in Europe. The order will result in revenue to Asetek in the range of \$100,000 with installation expected to occur in Q3 2016. The OEM partner as well as the installation site will be announced at a later date.

“Although this particular order is small, the strategic value of repeat business is big,” said André Sloth Eriksen, Founder and CEO of Asetek. “We appreciate that one of our existing OEMs has placed a repeat order to provide our liquid cooling technology to an HPC customer that appreciates our offering.”

For further information, please contact:

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